

REMARKS

In view of the comments of the examiner in the Advisory Action mailed 05/01/2007, the claims have been amended above to put the term "die-cast" in the body of the independent claims.

As noted in the Response filed 4/12/2007, a "die-cast" member has structural attributes which the housing 20 of Benzoni does not have. Benzoni merely discloses that the housing 20 comprises a molded non-conductive member; such as molded plateable engineering grade plastic (column 2, lines 26-27 and 38-40). Surfaces of the housing 20 are plated with an electrically conductive material, such as copper (column 3, lines 29-31). **A plastic member plated with metal is different from a die-cast member.** A die-cast member is more robust than a plastic member having a plated surface. A die-cast member has different electrical conductivity than a plastic member having a plated surface; plastic is electrically insulative. A die-cast member has less resistance to conduct heat than a plastic member having a plated surface. A plastic member is more resistant to heat conduction than a die-cast member. A die-cast member can absorb more energy than a plastic member having a plated surface, such as when heating a solder pin; the terminal resistance fuse point is higher for a die cast member.

Favorable reconsideration and allowance is respectfully requested. Should any unresolved issue remain, the examiner is invited to call applicant's attorney at the telephone number indicated below.

Respectfully submitted,

Mark F. Harrington

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5/9/07

Date

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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail on the date shown below in an envelope addressed to: Commissioner For Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

May 9, 2007

Date

Mark F. Harrington

Name of Person Making Deposit